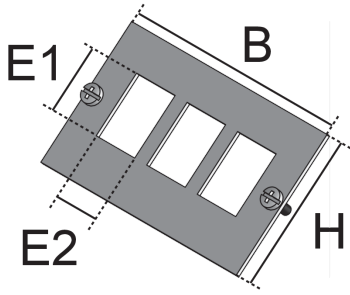


UDEP AMP

Mounting board, data technology

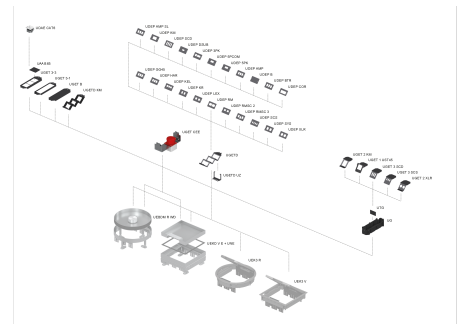
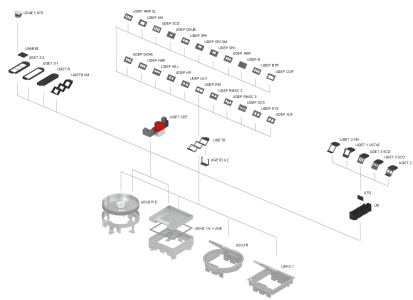
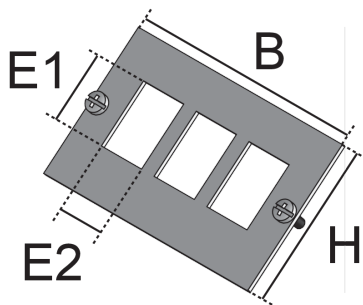


UDEP AMP components are installation boards from the underfloor system range. The boards are bolted into data device carriers and are used to accommodate a maximum of 3 AMP Corning data jacks FutureCom™ S1200 module Cat.7A from TE Connectivity or the TERA® 4-Pair Outlets made by Sieman. The installation boards are made of aluminium with a black coating on one side and have the installation dimensions of E1 19.3 mm and E2 14.6 mm.

Products	H	B	E1	E2	color	data jacks	weight
UDEP-AMP 3	46 mm	75 mm	19,3 mm	14,6 mm	SCHWARZ	3	0,014 kg

H: height
B: width
E1: fitting dimension E1
E2: fitting dimension E2
data jacks:

DETAIL AND APPLICATION IMAGES



OPTIONAL ACCESSORIES

UGETD

